# Triacs

## **Silicon Bidirectional Thyristors**

Designed for high performance full-wave ac control applications where high noise immunity and high commutating di/dt are required.

#### Features

- Blocking Voltage to 800 V
- On-State Current Rating of 16 A RMS at 80°C
- Uniform Gate Trigger Currents in Three Quadrants
- High Immunity to dV/dt 1500 V/µs minimum at 125°C
- Minimizes Snubber Networks for Protection
- Industry Standard TO-220AB Package
- High Commutating dI/dt 7.5 A/ms minimum at 125°C
- These are Pb-Free Devices

#### **MAXIMUM RATINGS** (T<sub>J</sub> = $25^{\circ}$ C unless otherwise noted)

	1		
Rating	Symbol	Value	Unit
Peak Repetitive Off-State Voltage (Note 1) ( $T_J = -40$ to 125°C, Sine Wave, 50 to 60 Hz, Gate Open)	V <sub>DRM,</sub> V <sub>RRM</sub>		V
BTB16-600BW3G BTB16-700BW3G BTB16-800BW3G		600 700 800	
On-State RMS Current (Full Cycle Sine Wave, 60 Hz, T <sub>C</sub> = 80°C)	I <sub>T(RMS)</sub>	16	A
Peak Non-Repetitive Surge Current (One Full Cycle Sine Wave, 60 Hz, $T_C = 25^{\circ}C$ )	I <sub>TSM</sub>	170	A
Circuit Fusing Consideration (t = 8.3 ms)	l <sup>2</sup> t	120	A <sup>2</sup> sec
Non-Repetitive Surge Peak Off-State Voltage ( $T_J$ = 25°C, t = 8.3 ms)	V <sub>DSM/</sub> V <sub>RSM</sub>	$V_{\text{DSM}/V_{\text{RSM}}}$ +100	V
Peak Gate Current (T <sub>J</sub> = 125°C, t $\leq$ 20 $\mu$ s)	I <sub>GM</sub>	4.0	А
Average Gate Power ( $T_J = 125^{\circ}C$ )	P <sub>G(AV)</sub>	1.0	W
Operating Junction Temperature Range	TJ	-40 to +125	°C
Storage Temperature Range	T <sub>stg</sub>	-40 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

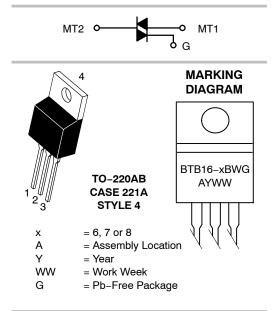
 V<sub>DRM</sub> and V<sub>RRM</sub> for all types can be applied on a continuous basis. Blocking voltages shall not be tested with a constant current source such that the voltage ratings of the devices are exceeded.



## **ON Semiconductor®**

http://onsemi.com

## TRIACS 16 AMPERES RMS 600 thru 800 VOLTS



PIN ASSIGNMENT				
1	Main Terminal 1			
2	Main Terminal 2			
3	Gate			
4	Main Terminal 2			

#### **ORDERING INFORMATION**

Device	Package	Shipping
BTB16-600BW3G	TO-220AB (Pb-Free)	50 Units / Rail
BTB16-700BW3G	TO-220AB (Pb-Free)	50 Units / Rail
BTB16-800BW3G	TO-220AB (Pb-Free)	50 Units / Rail

\*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

#### THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction-to-Case (AC) Junction-to-Ambient	$R_{ heta JC} \ R_{ heta JA}$	1.9 60	°C/W
Maximum Lead Temperature for Soldering Purposes 1/8" from Case for 10 seconds	ΤL	260	°C

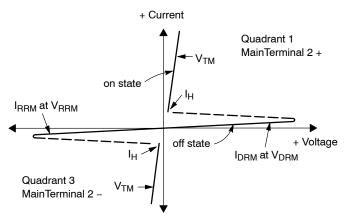
**ELECTRICAL CHARACTERISTICS** ( $T_J$  = 25°C unless otherwise noted; Electricals apply in both directions)

Characteristic	Symbol	Min	Тур	Max	Unit
OFF CHARACTERISTICS					
	= 25°C   <sub>DRM</sub> / = 125°C   <sub>RRM</sub>			0.005 2.0	mA
ON CHARACTERISTICS				•	•
Peak On-State Voltage (Note 2) $(I_{TM} = \pm 22.5 \text{ A Peak})$	V <sub>TM</sub>	-	-	1.55	V
Gate Trigger Current (Continuous dc) (V <sub>D</sub> = 12 V, R <sub>L</sub> = 30 $\Omega$ ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	I <sub>GT</sub>	2.5 2.5 2.5		50 50 50	mA
Holding Current ( $V_D = 12 V$ , Gate Open, Initiating Current = ±150 mA)	I <sub>H</sub>	_	-	60	mA
Latching Current (V <sub>D</sub> = 12 V, I <sub>G</sub> = 50 mA) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	ι			70 90 70	mA
Gate Trigger Voltage (V <sub>D</sub> = 12 V, R <sub>L</sub> = 30 $\Omega$ ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	V <sub>GT</sub>	0.5 0.5 0.5		1.7 1.1 1.1	V
Gate Non-Trigger Voltage ( $T_J = 125^{\circ}C$ ) MT2(+), G(+) MT2(+), G(-) MT2(-), G(-)	V <sub>GD</sub>	0.2 0.2 0.2	_ _ _		V
DYNAMIC CHARACTERISTICS					
Rate of Change of Commutating Current, See Figure 10. (Gate Open, $T_J = 125^{\circ}$ C, No Snubber)	(dl/dt) <sub>c</sub>	7.5	-	-	A/ms
Critical Rate of Rise of On–State Current $(T_J = 125^{\circ}C, f = 120 \text{ Hz}, I_G = 2 \text{ x } I_{GT}, tr \le 100 \text{ ns})$	dl/dt	_	-	50	A/μs
Critical Rate of Rise of Off-State Voltage $(V_D = 0.66 \times V_{DRM}, Exponential Waveform, Gate Open, T_J = 125^{\circ}C)$	dV/dt	1500	-	-	V/μs

2. Indicates Pulse Test: Pulse Width  $\leq$  2.0 ms, Duty Cycle  $\leq$  2%.

#### Voltage Current Characteristic of Triacs (Bidirectional Device)

Symbol	Parameter
V <sub>DRM</sub>	Peak Repetitive Forward Off State Voltage
I <sub>DRM</sub>	Peak Forward Blocking Current
V <sub>RRM</sub>	Peak Repetitive Reverse Off State Voltage
I <sub>RRM</sub>	Peak Reverse Blocking Current
V <sub>TM</sub>	Maximum On State Voltage
I <sub>H</sub>	Holding Current

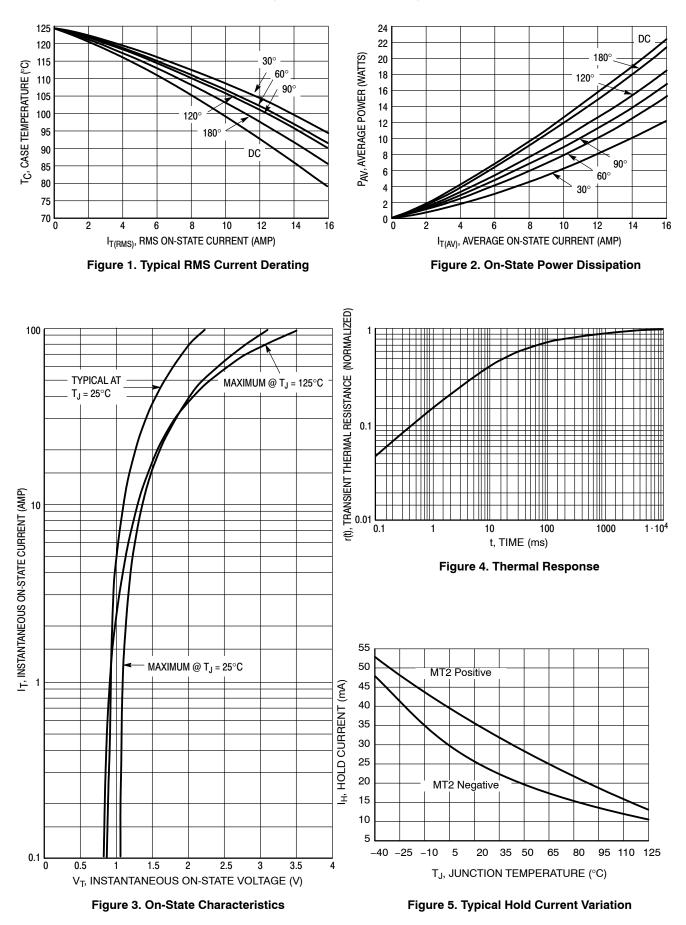


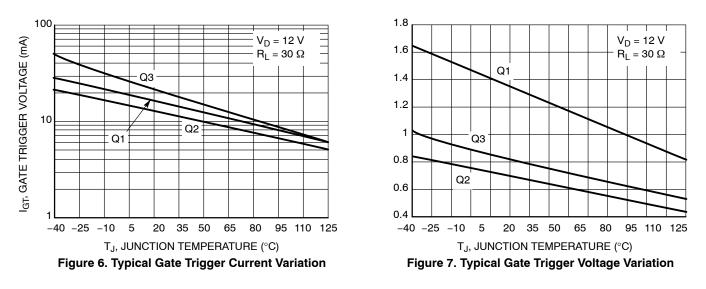
#### MT2 POSITIVE (Positive Half Cycle) (+) MT2 (+) MT2 Quadrant II Quadrant I (-) I<sub>GT</sub> GATE (+) I<sub>GT</sub> GATE 0 0 **ф** МТ1 **ф** МТ1 = -REF REF + I<sub>GT</sub> IGT (-) MT2 (-) MT2 Quadrant III **Quadrant IV** (+) I<sub>GT</sub> GATE (-) I<sub>GT</sub> GATE 0 O-MT1 **ф** МТ1 Ξ REF REF MT2 NEGATIVE (Negative Half Cycle)

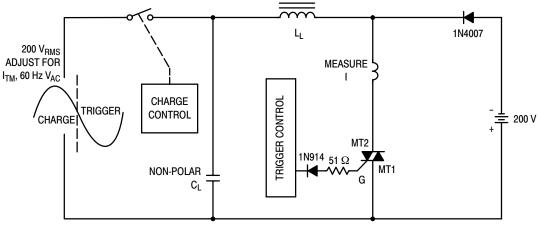
#### **Quadrant Definitions for a Triac**

All polarities are referenced to MT1.

With in-phase signals (using standard AC lines) quadrants I and III are used.





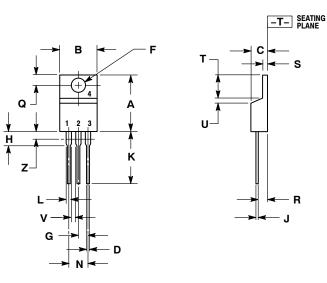


Note: Component values are for verification of rated (di/dt)c. See AN1048 for additional information.

Figure 8. Simplified Test Circuit to Measure the Critical Rate of Rise of Commutating Current (di/dt)c

#### PACKAGE DIMENSIONS

**TO-220** CASE 221A-07 ISSUE AA



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI

Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH.

 CONTROLLING DIMENSION: INCH.
DIMENSION Z DEFINES A ZONE WHERE ALL BODY AND LEAD IRREGULARITIES ARE

ALLOWED.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.570	0.620	14.48	15.75
В	0.380	0.405	9.66	10.28
С	0.160	0.190	4.07	4.82
D	0.025	0.035	0.64	0.88
F	0.142	0.147	3.61	3.73
G	0.095	0.105	2.42	2.66
Н	0.110	0.155	2.80	3.93
J	0.014	0.022	0.36	0.55
K	0.500	0.562	12.70	14.27
L	0.045	0.060	1.15	1.52
Ν	0.190	0.210	4.83	5.33
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.15	1.39
Т	0.235	0.255	5.97	6.47
U	0.000	0.050	0.00	1.27
۷	0.045		1.15	
Ζ		0.080		2.04

STYLE 4:

PIN 1. MAIN TERMINAL 1 2. MAIN TERMINAL 2

3. GATE

4. MAIN TERMINAL 2

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